Onsemi

IGBT – Power, Co-PAK N-Channel, Field Stop VII (FS7), Non SCR, Power TO247-3L, 1200 V, 1.7 V, 75 A

FGY75T120SWD

Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 3-lead package, FGY75T120SWD offers the optimum performance with low switching and conduction losses for high-efficiency operations in various applications like Solar, UPS and ESS.

Features

- Maximum Junction Temperature $T_J = 175^{\circ}C$
- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- Smooth and Optimized Switching
- Low Switching Loss
- RoHS Compliant

Applications

- Boost and Inverter in Solar System
- UPS
- Energy Storage System

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

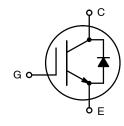
Paramete	Symbol	Value	Unit	
Collector to Emitter Voltage		V _{CES}	1200	V
Gate to Emitter Voltage	V _{GES}	±20		
Transient Gate to Emitter		±30		
Collector Current	$T_{C} = 25^{\circ}C$	Ι _C	150	
	$T_{\rm C} = 100^{\circ}{\rm C}$		75	A
Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	PD	503	W
	$T_{\rm C} = 100^{\circ}{\rm C}$		251	
Pulsed Collector Current	T _C = 25°C, t _p = 10 μs (Note 1)	I _{СМ}	300	A
Diode Forward	$T_{C} = 25^{\circ}C$	١ _F	150	
Current	$T_{\rm C} = 100^{\circ}{\rm C}$		75	
Pulsed Diode Maximum Forward Current	T _C = 25°C, t _p = 10 μs (Note 1)	I _{FM}	300	
Operating Junction and Storage Temperature		T _J , T _{STG}	–55 to 175	°C
Lead Temperature for Sol	dering Purposes	ΤL	260	

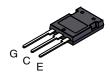
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse width limited by max. Junction temperature.

BV _{CES}	V _{CE(SAT)}	I _C
1200 V	1.7 V	75.0 A

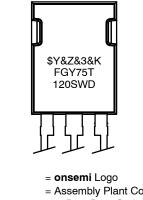
PIN CONNECTIONS





TO247-3LD CASE 340CD

MARKING DIAGRAM



=	= A:	sse	mbly	ΡI	ant	Code

= 3-Digit Date Code

= 2-Digit Lot Traceability Code

FGY75T120SWD = Specific Device code

\$Y

&Z

&3

&K

ORDERING INFORMATION

Device	Package	Shipping
FGY75T120SWD	TO247–3LD (Pb–Free)	30 Units / Tube

THERMAL CHARACTERISTICS

Parameter	Symbol	Max Value	Unit
Thermal Resistance, Junction to Case for IGBT	$R_{\theta JC}$	0.3	°C/W
Thermal Resistance, Junction to Case for Diode		0.4	
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	40	

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_J = $25^{\circ}C$ unless otherwise noted)

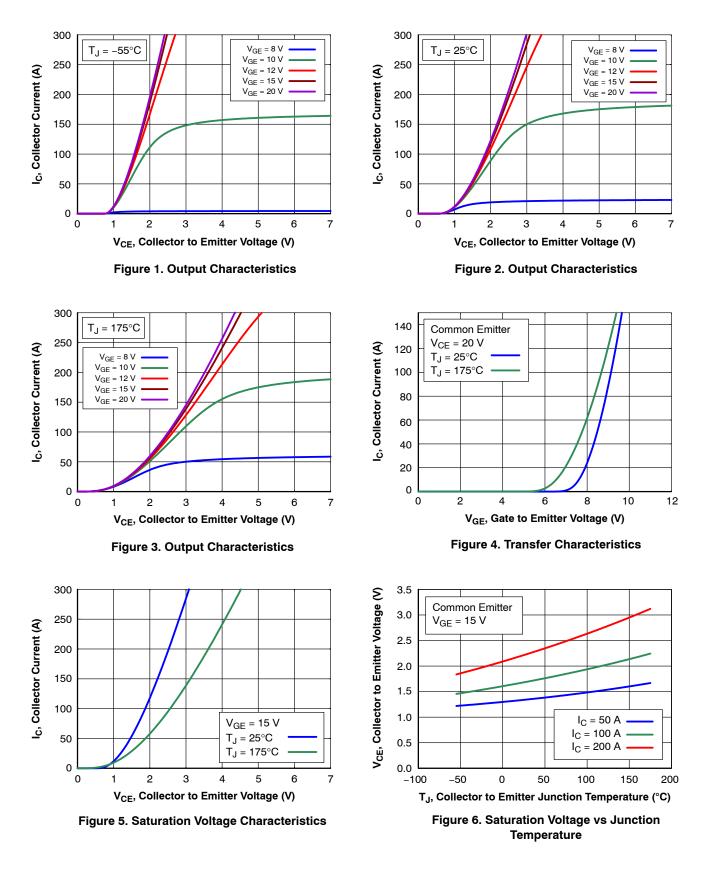
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•					
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 5 mA	1200	-	-	V
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{CES}} / \Delta \text{T}_{\text{J}}$	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 5 \text{ mA}$	-	666	_	mV/°C
Collector to Emitter Cut-Off Current	I _{CES}	V_{GE} = 0 V, V_{CE} = V_{CES}	_	-	40	μΑ
Gate to Emitter Leakage Current	I _{GES}	V_{GE} = 20 V, V_{CE} = 0 V	-	-	±400	nA
ON CHARACTERISTICS						
Gate to Emitter Threshold Voltage	V _{GE(TH)}	$V_{GE} = V_{CE}$, $I_C = 75 \text{ mA}$	5.6	6.55	7.4	V
Collector to Emitter Saturation	V _{CE(SAT)}	V_{GE} = 15 V, I _C = 75 A, T _J = 25°C	1.35	1.68	2.0	V
Voltage		V_{GE} = 15 V, I _C = 75 A, T _J = 175°C	-	2.24	-	1
DYNAMIC CHARACTERISTICS	_	· · · · · · · · · · · · · · · · · · ·				
Input Capacitance	C _{IES}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	6331	-	pF
Output Capacitance	C _{OES}		-	234	-	
Reverse Transfer Capacitance	C _{RES}		-	29.6	-	
Total Gate Charge	Q _G	V_{CE} = 600 V, V_{GE} = 15 V, I_{C} = 75 A	-	214	-	nC
Gate to Emitter Charge	Q _{GE}		-	53.9	-	
Gate to Collector Charge	Q _{GC}		-	77.7	-	
SWITCHING CHARACTERISTIC, I	NDUCTIVE LOAI	D				
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	42	-	ns
Turn-Off Delay Time	t _{d(off)}	$I_{C} = 37.5 \text{ A}, \text{ R}_{G} = 4.7 \Omega,$ T _J = 25°C	-	221	-	ns
Rise Time	t _r		-	27	-	ns
Fall Time	t _f		-	77	-	
Turn-On Switching Loss	E _{on}		-	2.12	-	mJ
Turn-Off Switching Loss	E _{off}		-	1.43	-	
Total Switching Loss	E _{ts}		-	3.55	-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	42	-	ns
Turn-Off Delay Time	t _{d(off)}	I _C = 75 A, R _G = 4.7 Ω, T _J = 25°C	-	171	-	ns
Rise Time	t _r		-	56	-	ns
Fall Time	t _f		-	66	-	1
Turn-On Switching Loss	E _{on}		-	5.00	-	mJ
Turn-Off Switching Loss	E _{off}		-	2.32	-	1
Total Switching Loss	E _{ts}	1 1	-	7.32	-	

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_J = 25°C unless otherwise noted) (continued)

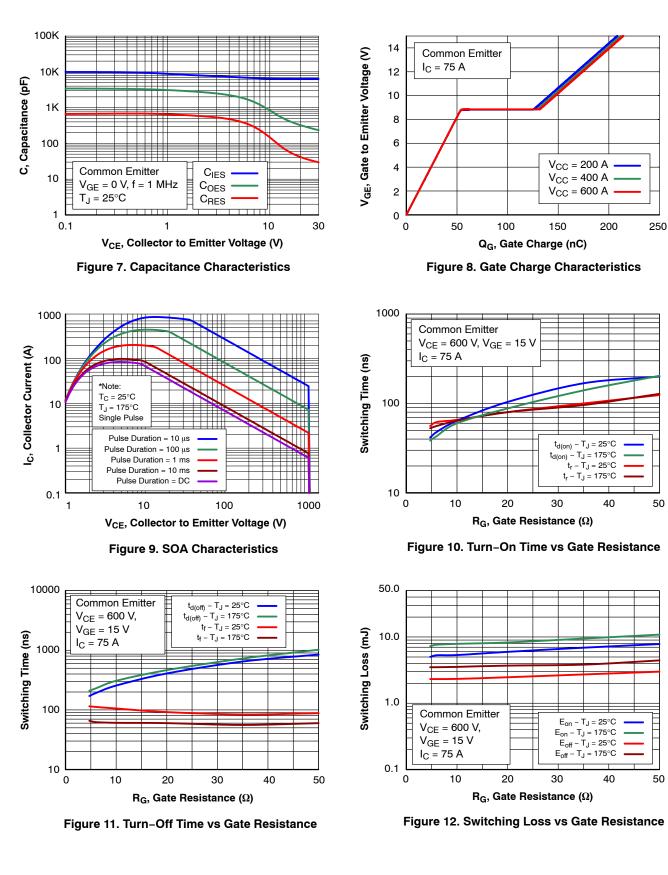
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTIC, II	NDUCTIVE LOA	ND	ł	1	1	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	38	-	ns
Turn-Off Delay Time	t _{d(off)}	I _C = 37.5 A, R _G = 4.7 Ω, T _J = 175°C	-	276	_	ns
Rise Time	t _r		-	26	-	ns
Fall Time	t _f		-	132	-	
Turn-On Switching Loss	Eon		_	3.50	-	mJ
Turn-Off Switching Loss	E _{off}		_	2.31	-	
Total Switching Loss	E _{ts}		-	5.81	-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	38	-	ns
Turn-Off Delay Time	t _{d(off)}	I _C = 75 A, R _G = 4.7 Ω, T _J = 175°C	-	210	-	ns
Rise Time	t _r		-	53	-	ns
Fall Time	t _f		-	115	-	
Turn-On Switching Loss	E _{on}		_	7.29	-	mJ
Turn-Off Switching Loss	E _{off}	1	-	3.50	-	
Total Switching Loss	E _{ts}		-	10.79	-	
DIODE CHARACTERISTIC						
Diode Forward Voltage	V _F	I _F = 75 A, T _J = 25°C	1.62	1.84	2.22	V
		$I_F = 75 \text{ A}, T_J = 175^{\circ}\text{C}$ –	-	1.91	-	
DIODE SWITCHING CHARACTER	STIC, INDUCTI	VE LOAD				
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 37.5 \text{ A},$	-	233	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs, T _J = 25°C	-	2343	-	nC
Reverse Recovery Energy	E _{rec}		-	0.8	-	mJ
Peak Reverse Recovery Current	I _{RRM}	1	-	20.2	-	A
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 75 \text{ A},$	-	307	-	nS
Reverse Recovery Charge	Q _{rr}	dl _F /dt = 500 A/μs, T _J = 25°C	-	3285	-	nC
Reverse Recovery Energy	E _{rec}	1	-	1	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	21.4	-	A
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 37.5 \text{ A},$	-	407	-	ns
Reverse Recovery Charge	Q _{rr}	dl _F /dt = 500 A/µs, T _J = 175°C	-	5965	-	nC
Reverse Recovery Energy	E _{rec}		_	2	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	29.4	-	А
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 75 \text{ A},$	-	541	-	ns
Reverse Recovery Charge	Q _{rr}	dl _F /dt = 500 A/μs, T _J = 175°C	-	8974	-	nC
Reverse Recovery Energy	E _{rec}]	-	4	-	mJ
Peak Reverse Recovery Current	I _{RRM}	1	-	33.2	-	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)



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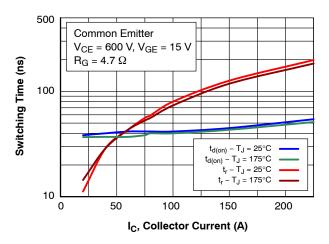


Figure 13. Turn-On Time vs Collector Current

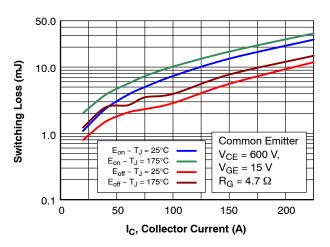


Figure 15. Switching Loss vs Collector Current

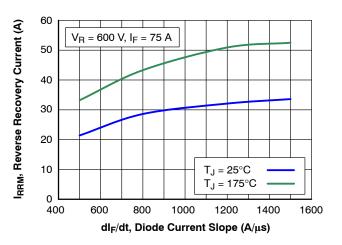


Figure 17. Diode Reverse Recovery Current

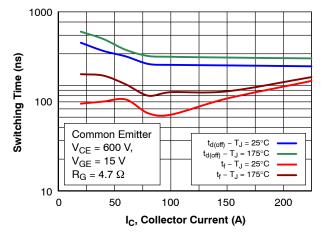


Figure 14. Turn-Off Time vs Collector Current

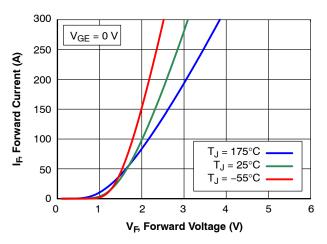


Figure 16. Diode Forward Characteristics

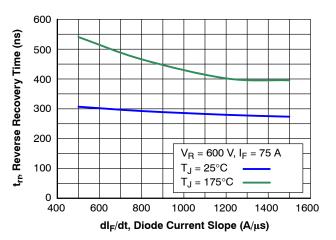
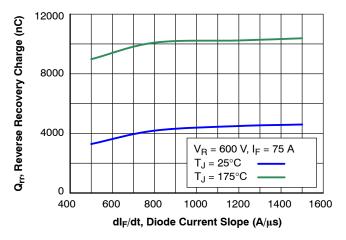
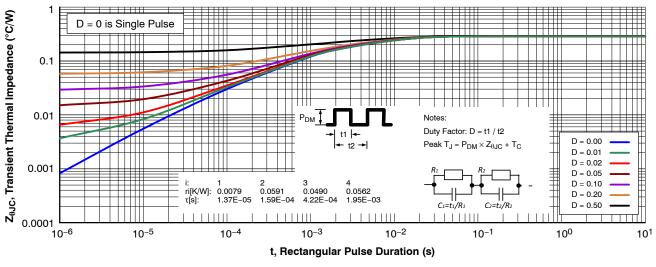


Figure 18. Diode Reverse Recovery Time

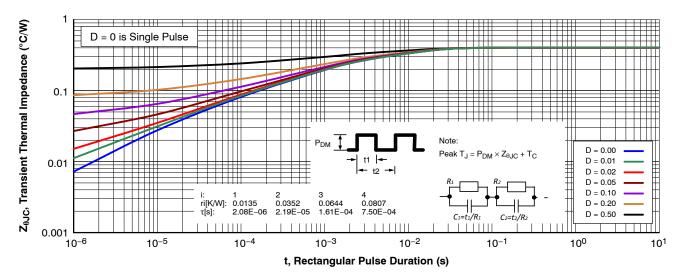
TYPICAL CHARACTERISTICS (CONTINUED)





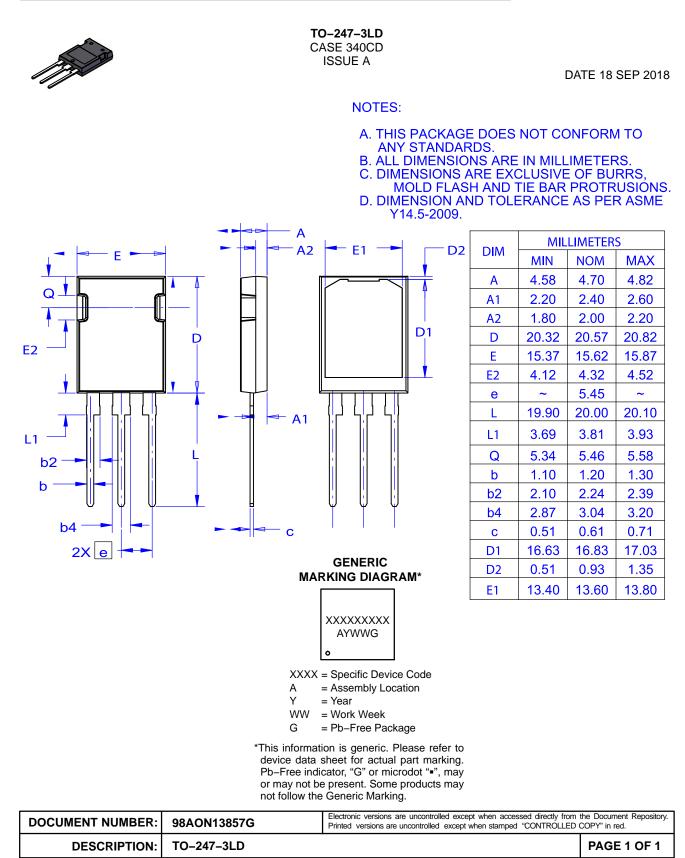












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